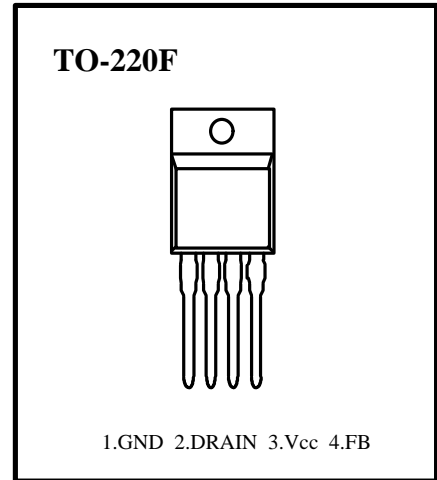


KA1M0280R

SAMSUNG POWER SWITCH

FEATURES

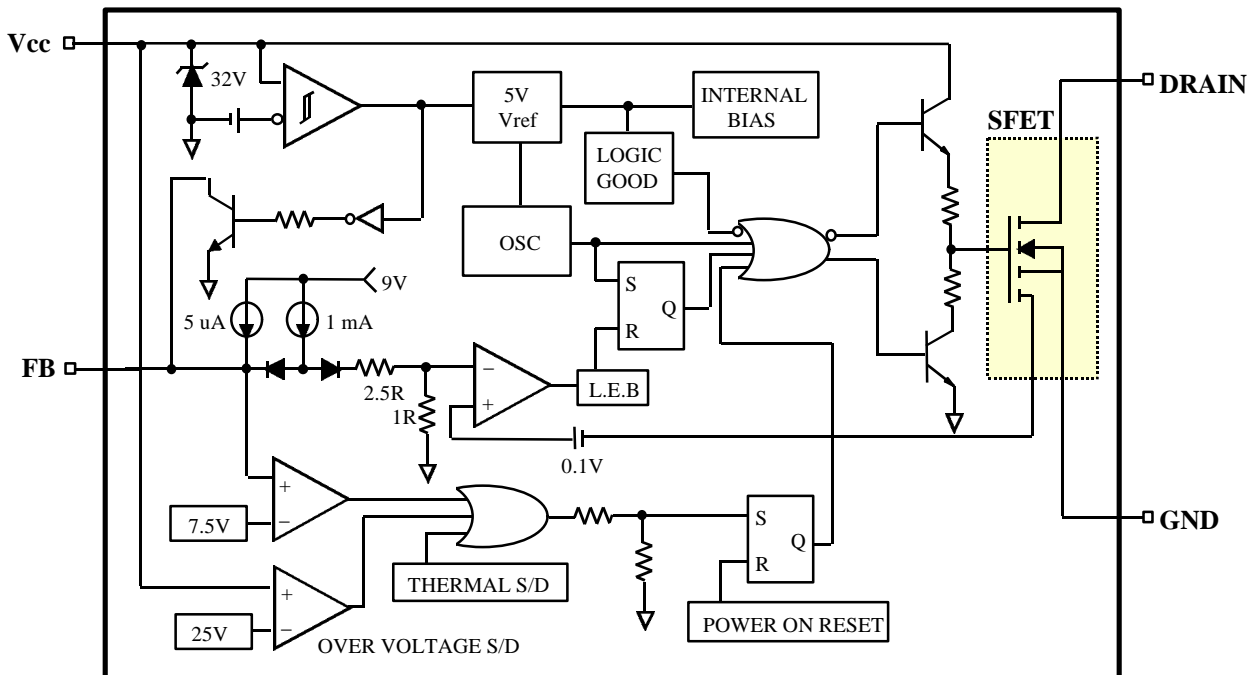
- Precision fixed operating frequency (70KHz)
- Pulse by pulse over current limiting
- Over Current Protection
- Over Voltage Protection(min. 23V)
- Internal thermal shutdown function
- Under voltage lockout
- Internal high voltage sense FET
- Auto restart



PRODUCT SUMMARY

Part Number	BVdss	Rds(on)	Id
KA1M0280R	800V	7.0Ω	2A

BLOCK DIAGRAM



ABSOLUTE MAXIMUM RATINGS

Characteristic	Symbol	Value	Unit
Drain - Source(GND) Voltage (1)	V _{DSS}	800	V
Drain - Gate Voltage (R _{Gs} = 1M Ω)	V _{DGR}	800	V
Gate - Source(GND) Voltage	V _{GS}	30	V
Drain Current Pulsed (2)	I _{DM}	8.0	A _{DC}
Single Pulsed Avalanche Energy (3)	E _{AS}	90	mJ
Avalanche Current	I _{AS}	2.0	A
Continuous Drain Current (T _c = 25 $^{\circ}$ C)	I _D	2.0	A _{DC}
Continuous Drain Current (T _c = 100 $^{\circ}$ C)	I _D	1.3	A _{DC}
Supply Voltage	V _{CC}	30	V
Analog Input Voltage Range	V _{FB}	-0.3 ~ V _{SD}	V
Total Power Dissipation	P _D (wt H/S)	35	W
	Derating	0.28	W/ $^{\circ}$ C
Operating Temperature	T _{OPR}	- 25 ~ + 85	$^{\circ}$ C
Storage Temperature	T _{STG}	- 55 ~ + 150	$^{\circ}$ C

Notes: (1) T_J = 25 $^{\circ}$ C to 150 $^{\circ}$ C

(2) Repetitive rating : Pulse width limited by maximum junction temperature

(3) L = 51mH, V_{DD} = 50V, R_G = 25 Ω starting T_j = 25 $^{\circ}$ C

ELECTRICAL CHARACTERISTICS (SFET part)

(Ta = 25 $^{\circ}$ C unless otherwise specified)

Symbol	Characteristic	Min	Typ	Max	Units	Test Conditions
BV _{DSS}	Drain-Source Breakdown Voltage	800	-	-	V	V _{GS} =0V, I _D =50uA
I _{DSS}	Zero Gate Voltage Drain Current	-	-	50	uA	V _{DS} =Max, Rating, V _{GS} =0V
		-	-	200	uA	V _{DS} =0.8Max, Rating, V _{GS} =0V TC=125 $^{\circ}$ C
R _{DS(on)}	Static Drain-Source On Resistance(4)	-	5.6	7	Ω	V _{GS} = 10V, I _D = 0.5A

ELECTRICAL CHARACTERISTICS (SFET part continued)

(Ta = 25 ; Unless otherwise specified)

Symbol	Characteristic	Min	Typ	Max	Units	Test Conditions
gfs	Forward Transconductance(4)	1.5	2.5	-	mho	VDS=50V, ID=0.5A
Ciss	Input Capacitance	-	250	-	pF	VGS = 0V, VDS = 25V, f = 1MHz
Coss	Output Capacitance	-	52	-		
Crss	Reverse Transfer Capacitance	-	25	-		
td(on)	Turn On Delay Time	-	21	-	nS	VDD = 0.5BV _{DSS} , ID = 2.0A (MOSFET switching time are essentially independent of operating temperature)
tr	Rise Time	-	28	-		
td(off)	Turn Off Delay Time	-	77	-		
tf	Fall Time	-	24	-		
Qg	Total Gate Charge (Gate-Source + Gate-Drain)	-	-	60	nC	VGS = 10V, ID = 2.0A VDS = 0.5BV _{DSS} (MOSFET switching time are essentially independent of operating temperature)
Qgs	Gate-Source Charge	-	15	-		
Qgd	Gate-Drain(Miller) Charge	-	20	-		

Notes: (1) Tj = 25 ; to 150 ;

(2) Repetitive rating : Pulse width limited by maximum junction temperature

(3) L = 51mH, VDD = 50V, RG = 25 ; starting Tj = 25 ;

(4) Pulse Test : Pulse width ; 300uS, Duty Cycle ; %

ELECTRICAL CHARACTERISTICS (Control part)

(Ta = 25 ; Unless otherwise specified)

Symbol	Characteristics	Min	Typ	Max	Unit	Test Conditions
REFERENCE SECTION						
Vref	Output Voltage (Note 1)	4.80	5.00	5.20	V	Ta = 25 ;
Vref/ ;	Temperature Stability (Note 1&2)	-	0.3	0.6	mV/ ;	-25 ; ; Ta ; 85 ;
OSCILLATOR SECTION						
FOSC	Initial Accuracy	61	67	73	KHz	Ta = 25 ;
; / ;	Frequency Change with Temperature (Note 2)	-	;	;	%	-25 ; ; Ta ; 85 ;
PWM SECTION						
DMAX	Maximum Duty Cycle	74	77	80	%	
FEEDBACK SECTION						
IFB	Feedback Source Current	0.7	0.9	1.1	mA	Ta = 25 ; ; 0 V ; Vfb ; V
Idelay	Shutdown Delay Current	4.0	5.0	6.0	uA	Ta = 25 ; ; 5 V ; Vfb ; VSD
OVER CURRENT PROTECTION SECTION						
IL(MAX)	Over Current Protection	1.05	1.20	1.35	A	Max. Inductor Current
UVLO SECTION						
Vth(H)	Start Threshold Voltage	14	15	16	V	
Vth(L)	Minimum Operating Voltage	9	10	11	V	After turn on

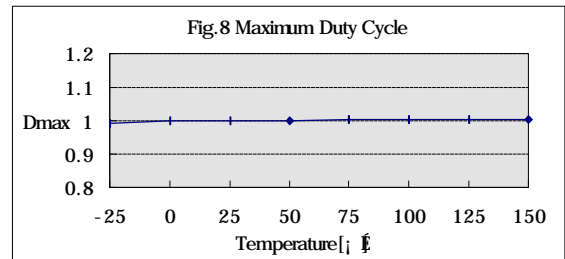
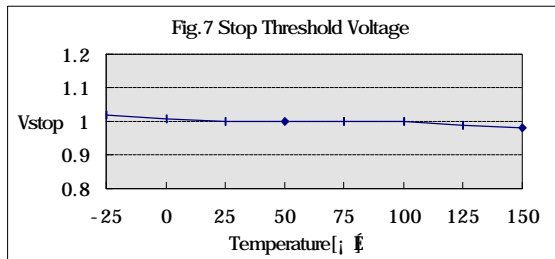
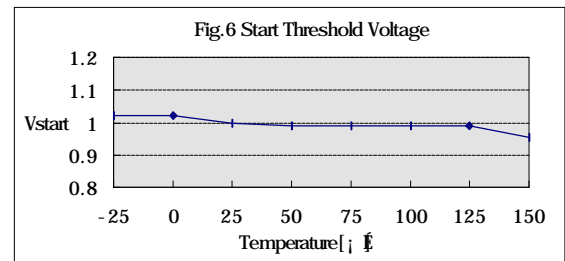
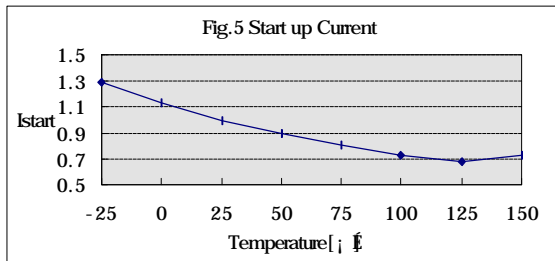
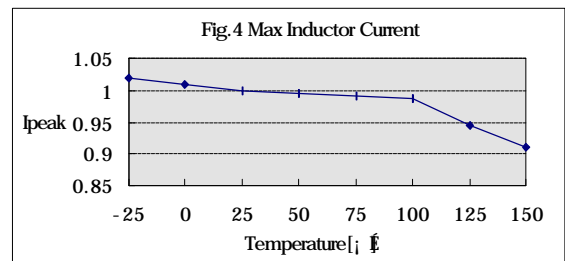
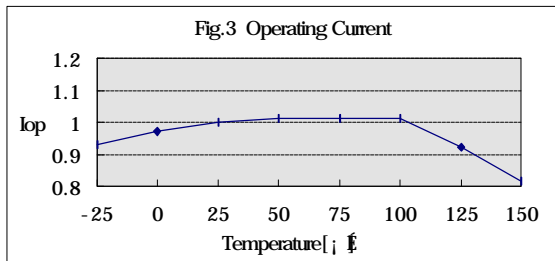
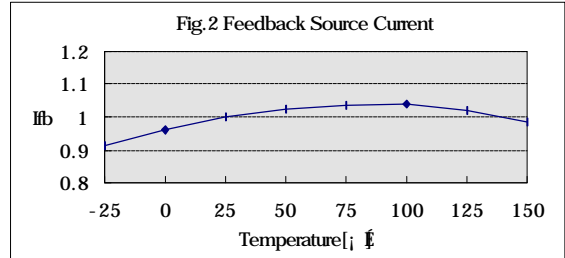
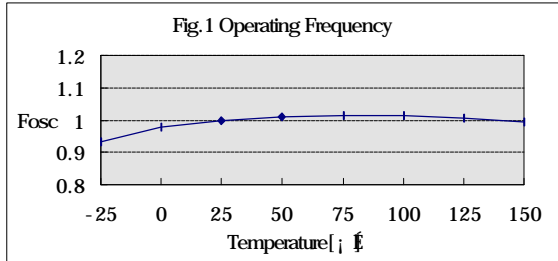
ELECTRICAL CHARACTERISTICS (Continued)

(Ta = 25 ; Unless otherwise specified)

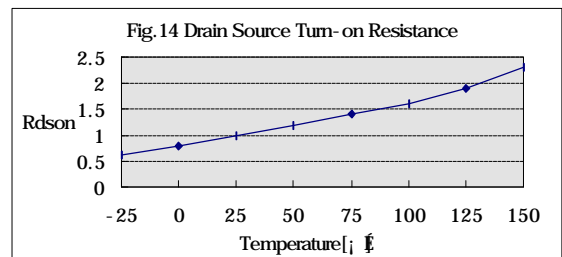
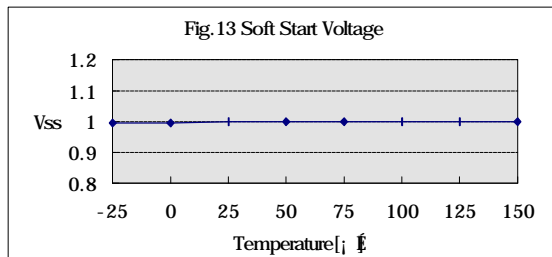
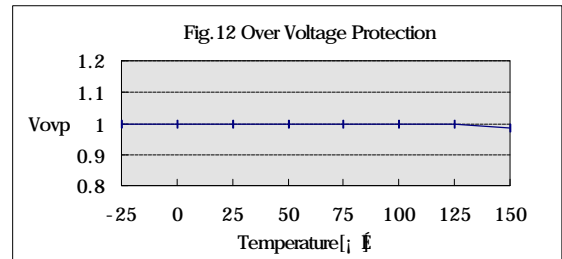
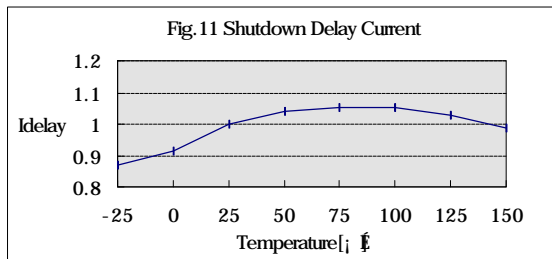
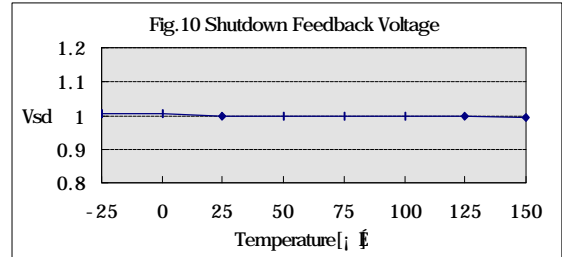
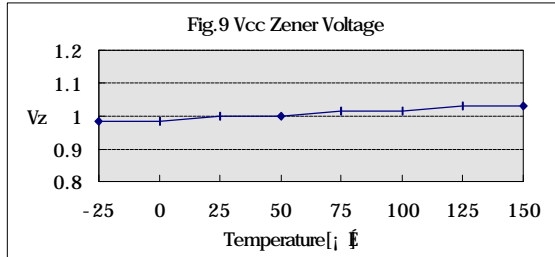
Symbol	Characteristics	Min	Typ	Max	Unit	Test Conditions
TOTAL STANDBY CURRENT SECTION						
I _{ST}	Start up Current	0.1	0.3	0.45	mA	V _{CC} = 14V
I _{OPR}	Operating Supply Current (control part only)	6	12	18	mA	Ta = 25 ;
V _Z	V _{CC} Zener Voltage	30	32.5	35	V	I _{CC} = 20mA
SHUTDOWN SECTION						
V _{SD}	Shutdown Feedback Voltage	6.9	7.5	8.1	V	
T _{SD}	Thermal Shutdown Temperature(T _j)	140	160	-	;	(Note 1)
V _{ovp}	Over Voltage Protection Voltage	23	25	28	V	

Notes: (1) These parameters, although guaranteed, are not 100% tested in production
(2) These parameters, although guaranteed, are tested in EDS(wafer test) process

TYPICAL PERFORMANCE CHARACTERISTICS

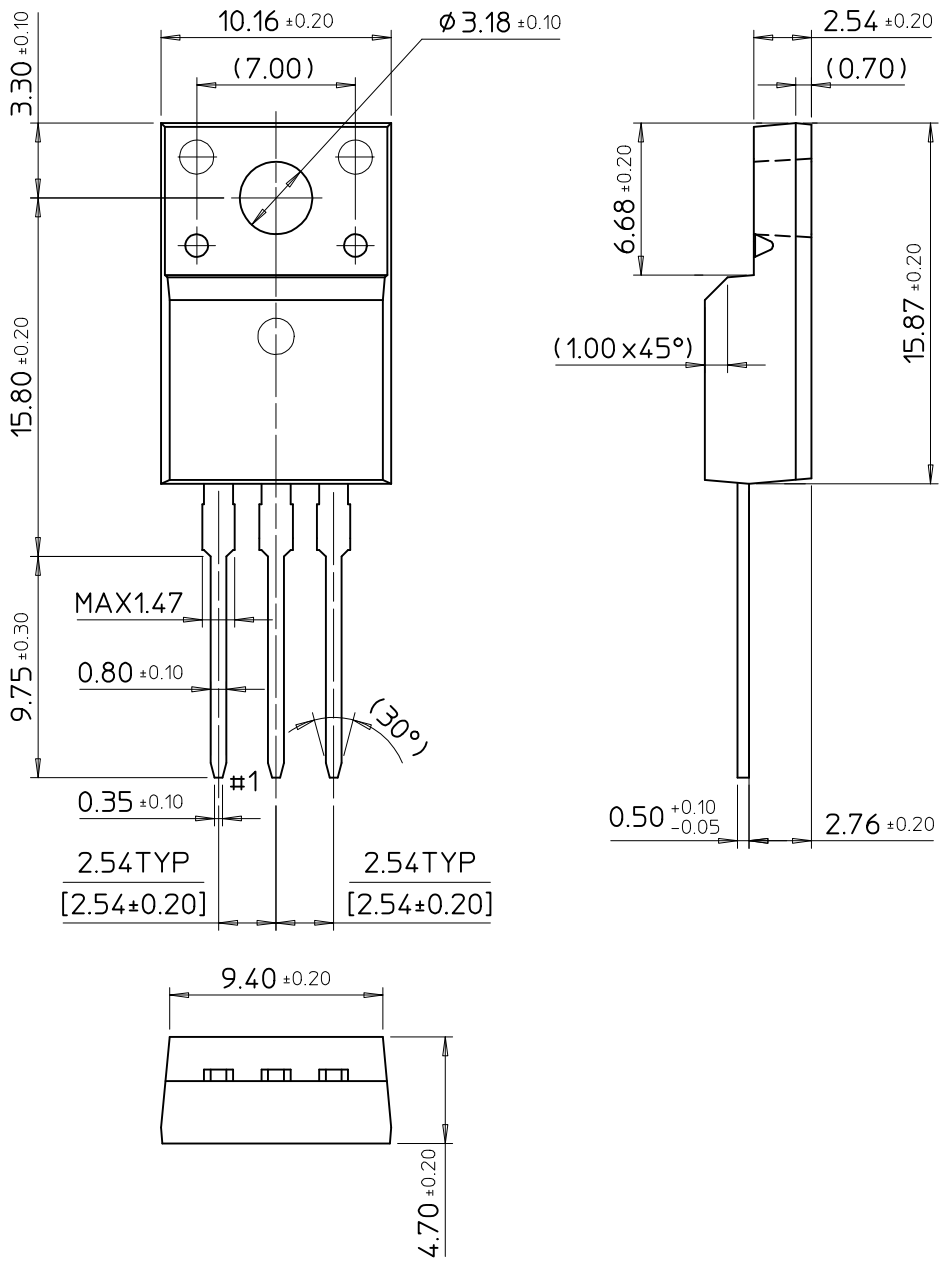


TYPICAL PERFORMANCE CHARACTERISTICS (Continued)



TO-220F

Dimensions in Millimeters



SAMSUNG ELECTRONICS CO.,LTD.